

Title (en)

A HEATSINK AND A METHOD AND AN ASSEMBLY FOR FORMING THE SAME

Title (de)

EINE WÄRMESENKE UND EIN VERFAHREN UND ZUSAMMENBAU ZUR HERSTELLUNG DERSELBEN

Title (fr)

DISSIPATEUR DE CHALEUR, PROCEDE ET ENSEMBLE DESTINE A FORMER CELUI-CI

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Application

EP 96914275 A 19960515

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Abstract (en)

[origin: GB2300974A] The invention provides a heatsink assembled from a planar base member (10) and a number of fin members (12). Each fin member has at least one fin portion (12a) and a base portion (12b) extending at an angle thereto. The fin member is attached to the base member by means of the base portion which, on fixing, lies coplanar with the base member. The fin member and base member are formed of thermally conductive material and preferably of the same material. The pin fin portions enhance the heat dissipation performance of the heatsink.

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